

ightarrow ightarrow ightarrow Inductors (Coils) ightarrow Detailed Information

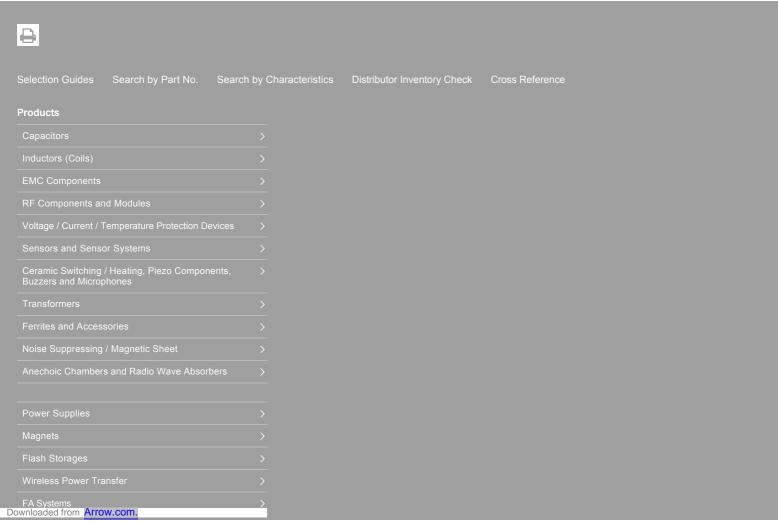
Inductors (Coils)

Product Top Pag	ge Search by Part No.	Search by Characteristics	Cross Reference	Catalog	Tech Notes	▼ more
MHQ04	02P0N8BT0	000				RoHS REACH Halogen Free Free
Applications	Commercial Grade Multilayer Non-Mag Core Super High Q					PDF file of this page
Feature			c)			Contact
Series Type	MHQ-P			•		Documents
Status	Production (Not Recommended for New Design) Recommended Alternate Part No. : <u>MHQ0402PSA0N8BT000</u> (Interc hangeability is not guaranteed.)		and	Images are for reference only and show exemplary products.	-	Catalog Catalog RoHS Certificate SVHC/REACH Certificate
Brand	TDK					 Product Lineup [Selection Guide] Inductors for high frequency applications Update
Size						Sample Kits
Length(L)		0.44mm ±0.0	2mm			Technical Support Tools
Width(W)		0.24mm ±0.0	2mm			S-parameter
Thickness Heig	ght	0.24mm ±0.0	2mm			SPICE Netlist (Simple)
Recommended	Land Pattern (A)	0.15mm to 0.	0.15mm to 0.20mm			SPICE Netlist (Precision)
Recommended Land Pattern (B)		0.20mm Nom	0.20mm Nom.			<u> </u>
Recommended Land Pattern (C)		0.18mm to 0.	0.18mm to 0.20mm			
Electrical Char	acteristics					
Inductance		0.8nH ±0.1n⊦	0.8nH ±0.1nH at 500MHz			
Rated Current		320mA	320mA			
DC Resistance	[Typ.]	70mΩ	70mΩ			
DC Resistance	[Max.]	200mΩ	200mΩ			
Self Resonant F	requency [Min.]	10GHz	10GHz			
Self Resonant F	requency [Typ.]	17.8GHz	17.8GHz			
Q [Min.]						
Q [Тур.]		12 at 500MH	12 at 500MHz			
Other						
Operating Temp. Range (Including Self-Temp. Rise)		mp. Rise) -55 to 125°C	-55 to 125°C			
Soldering Method		Reflow	Reflow			
AEC-Q200		No	No			
Packing		Punched (Pa	Punched (Paper)Taping [180mm Reel]			
Package Quanti	ity	20000pcs	20000pcs			
Weight		0.00011g	0.00011g			

Characteristic Graph (This is reference data, and does not guarantee the products characteristics.)

Impedance

MHQ0402P0N8BT000	MHQ0402P0N8BT000
Change settings	Change settings
Inductance	Q
MHQ0402P0N8BT000	MHQ0402P0N8BT000
Change settings	Change settings



Transparent Conductive Film	>	
Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)		
Solar Cells		
Biosensor		
Application Specific IC (ASIC) Development and Supply		
Application Guides		
Technical Support		
Tech Library		
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